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PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Yu Chao Lin	08/06/2009

RECEIVING PARTY DATA

Name:	Taiwan Semiconductor Manufacturing Company Ltd.	
Street Address:	No. 8, Li-Hsin Rd. 6	
Internal Address:	Science-Based Industrial Park	
City:	Hsin-Chu	
State/Country:	TAIWAN	
Postal Code:	300-77	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13408016

CORRESPONDENCE DATA

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Address Line 4: Dallas, TEXAS 75219

ATTORNEY DOCKET NUMBER: 2008-0505-D/24061.2097

NAME OF SUBMITTER: David M. O'Dell

Total Attachments: 1

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PATENT

REEL: 027803 FRAME: 0941

OF \$40.00 13408016

<u>Spirolet</u>

Docket No: 2008-0505 / 24061-1142 Customer No: 42717

ASSIGNMENT

WHEREAS, I, Yu Chao LIN, of Tainan County 717, Taiwan, R.O.C., has invented certain improvements in

METHODS OF PABRICATING HIGH-K METAL GATE DEVICES

for which I filed a patent application for letters patent in the United States of America on March 17, 2009, as U.S. Patent Application Serial No. 12/405,965.

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY, LTD., (hereinafter "ASSIGNEE", of No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, Republic of China is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged. I have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and I hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said ASSIGNEE, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I HEREBY covenant that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to said ASSIGNEE, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said ASSIGNEE, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

First Inventor Name:	Yn Chao LIN	
Residence Address:		, Thongjheng Rd., Rende Township 717, Taiwan, R.O.C.
Dated: 7019/08/	106 106	Inventor Signature Bao-Ming Gen
Dated: 08	f	Witness Signature Haw - Hung Lieu

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- 1 of 1 -

PATENT REEL: 027803 FRAME: 0942

RECORDED: 03/05/2012